## IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

#### Features

- Low Saturation Voltage using NPT Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- 10 µs Short Circuit Capability
- Low Gate Charge
- Soft, Fast Free Wheeling Diode
- These are Pb–Free Devices

#### **Typical Applications**

- Solar Inverter
- UPS Inverter

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CES</sub>	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι <sub>c</sub>	80 40	A
Pulsed collector current, T <sub>pulse</sub> limited by T <sub>Jmax</sub>	I <sub>CM</sub>	160	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I <sub>F</sub>	80 40	A
Diode pulsed current, $T_{\text{pulse}}$ limited by $T_{\text{Jmax}}$	I <sub>FM</sub>	160	A
Gate-emitter voltage Transient gate-emitter voltage $(T_{pulse} = 5 \ \mu s, D < 0.10)$	$V_{GE}$	±20 ±25	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P <sub>D</sub>	260 104	W
Short Circuit Withstand Time $V_{GE}$ = 15 V, $V_{CE}$ = 500 V, $T_J$ $\leq$ 150°C	T <sub>SC</sub>	10	μS
Operating junction temperature range	ТJ	–55 to +150	°C
Storage temperature range	T <sub>stg</sub>	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T <sub>SLD</sub>	260	°C

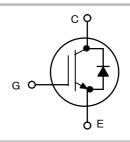
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

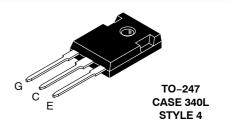


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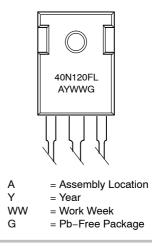
http://onsemi.com

40 A, 1200 V V<sub>CEsat</sub> = 2.0 V E<sub>off</sub> = 1.6 mJ





#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping
NGTB40N120FLWG	TO-247 (Pb-Free)	30 Units / Rail

#### THERMAL CHARACTERISTICS

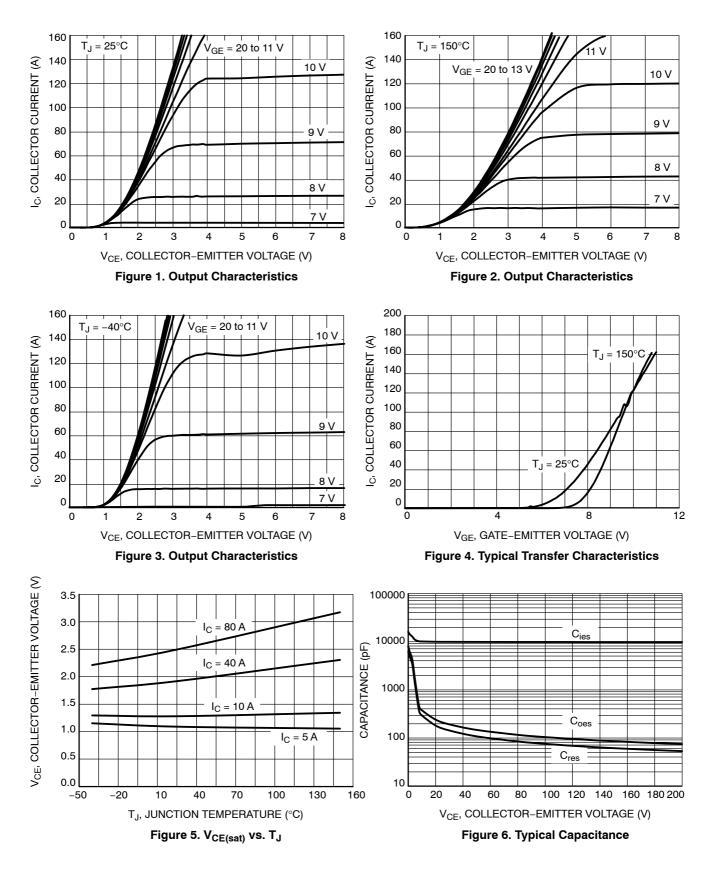
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.48	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

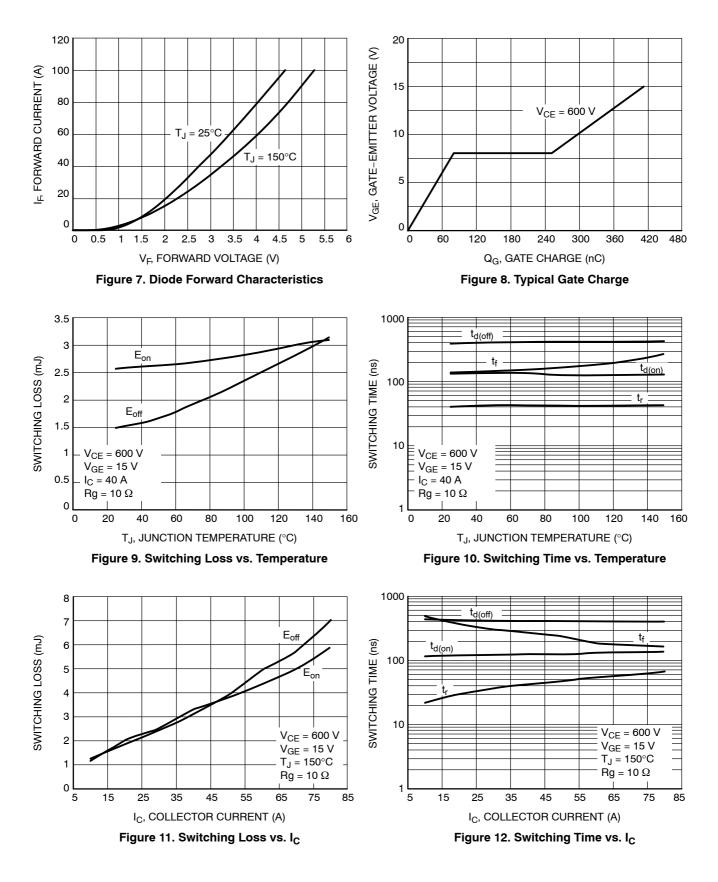
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

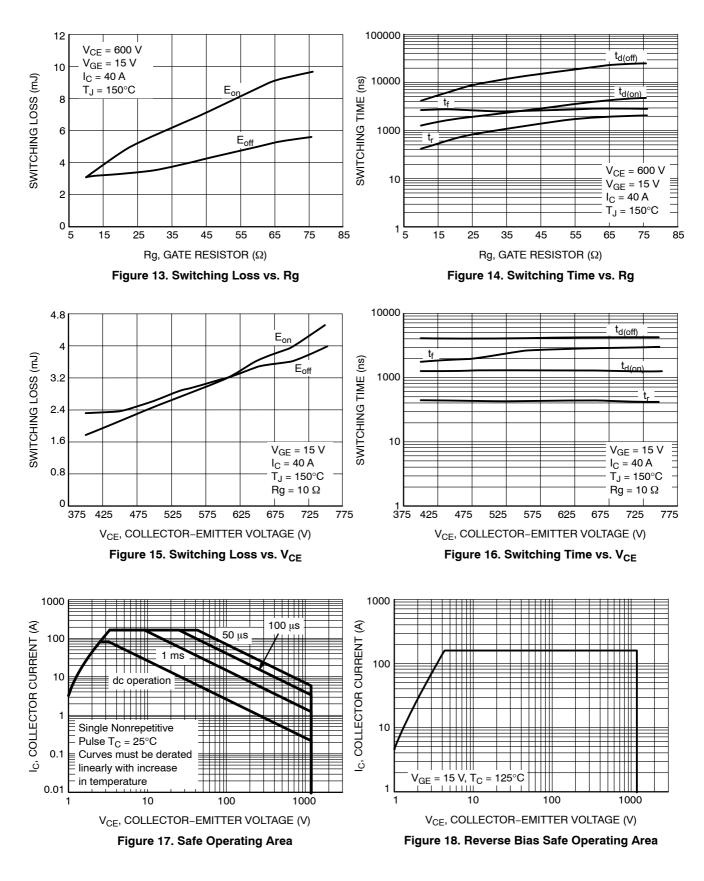
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 $\mu$ A	V <sub>(BR)CES</sub>	1200	-	-	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 40 A $V_{GE}$ = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 150°C	V <sub>CEsat</sub>	1.50 -	2.0 2.2	2.2	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 400 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J =} 150^{\circ}C$	I <sub>CES</sub>			1.0 2	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE}$ = 20 V , $V_{CE}$ = 0 V	I <sub>GES</sub>	_	-	200	nA
DYNAMIC CHARACTERISTIC	•	•				
Input capacitance		C <sub>ies</sub>	-	10,000	-	pF
Output capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>oes</sub>	-	240	-	
Reverse transfer capacitance		C <sub>res</sub>	-	180	-	
Gate charge total		Qg	-	415	-	nC
Gate to emitter charge	$V_{CE}$ = 600 V, I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V	Q <sub>ge</sub>	-	80	-	
Gate to collector charge		Q <sub>gc</sub>	-	170	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t <sub>d(on)</sub>	-	130	-	ns
Rise time		t <sub>r</sub>	-	41	-	
Turn-off delay time	T <sub>J</sub> = 25°C	t <sub>d(off)</sub>	-	385	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t <sub>f</sub>	-	140	-	
Turn-on switching loss	V <sub>GE</sub> = 0 V/ 15V	Eon	-	2.6	-	mJ
Turn-off switching loss	1	E <sub>off</sub>	-	1.6	-	
Total switching loss	1	E <sub>ts</sub>	-	4.2	-	
Turn-on delay time		t <sub>d(on)</sub>	-	130	-	ns
Rise time	1	t <sub>r</sub>	-	42	-	
Turn-off delay time	T <sub>J</sub> = 125°C	t <sub>d(off)</sub>	-	400	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $\text{R}_{g} = 10 \Omega$	t <sub>f</sub>	-	230	-	
Turn-on switching loss	$V_{GE} = 0 V/15V$	Eon	-	3.0	-	mJ
Turn-off switching loss	7	E <sub>off</sub>	-	2.8	-	
Total switching loss		E <sub>ts</sub>	-	5.8	-	

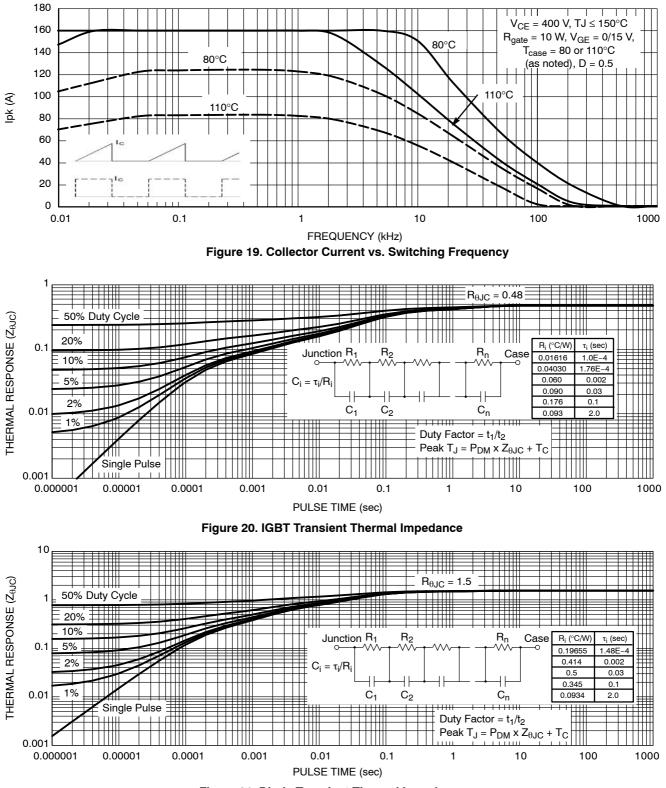
#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise specified)

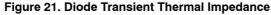
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTIC	<u>.</u>				•	
Forward voltage	$V_{GE}$ = 0 V, I <sub>F</sub> = 40 A V <sub>GE</sub> = 0 V, I <sub>F</sub> = 40 A, T <sub>J</sub> = 150°C	V <sub>F</sub>	-	2.7 3.5	3.5	V
Reverse recovery time	$T_J = 25^{\circ}C$	t <sub>rr</sub>	-	200	-	ns
Reverse recovery charge	I <sub>F</sub> = 40 A, V <sub>R</sub> = 400 V di <sub>F</sub> /dt = 200 A/μs	Q <sub>rr</sub>	-	1.5	-	μC
Reverse recovery current		I <sub>rrm</sub>	-	15	-	A
Reverse recovery time	T <sub>J</sub> = 125°C	t <sub>rr</sub>	-	260	-	ns
Reverse recovery charge	I <sub>F</sub> = 40 Å, V <sub>R</sub> = 400 V di <sub>F</sub> /dt = 200 Å/μs	Q <sub>rr</sub>	-	2.0	-	μC
Reverse recovery current		I <sub>rrm</sub>	-	22	-	A











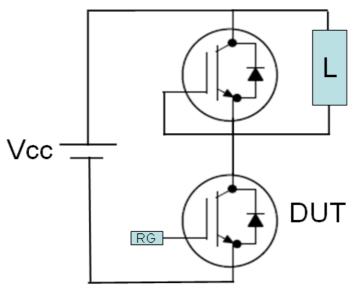
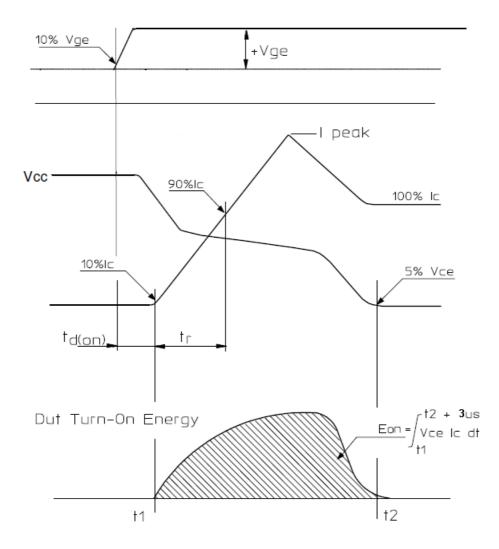


Figure 22. Test Circuit for Switching Characteristics





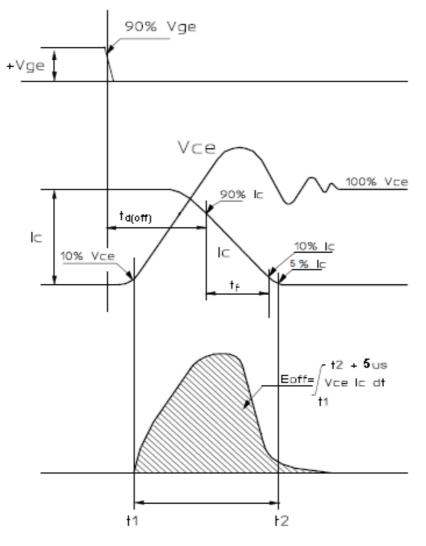


Figure 24. Definition of Turn Off Waveform

#### **MECHANICAL CASE OUTLINE** PACKAGE DIMENSIONS

2X F

# onsemi

TO-247 CASE 340L ISSUE G

DATE 06 OCT 2021

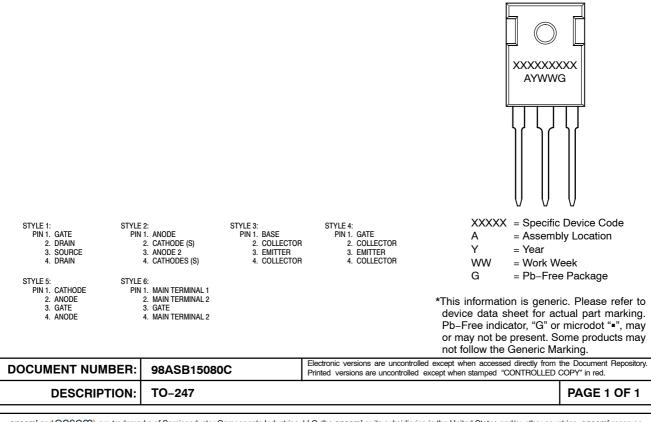
NUTES 1.

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2 CONTROLLING DIMENSION: MILLIMETER

SCALE 1:1	2. COM
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DIM	MIN.	MAX.	MIN.	MAX.
A	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242 BSC	
V	2.87	3.12	0.113	0.123

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